

### Product Change Notification / GBNG-14COLQ123

## Date:

27-Jul-2021

## **Product Category:**

Inductive Position Sensors

## **PCN Type:**

Manufacturing Change

## **Notification Subject:**

CCB 4485.001 Final Notice: Qualification of MMT as a new assembly site for selected Microsemi LX3301A device family available in 14L TSSOP (4.4mm) package.

## **Affected CPNs:**

GBNG-14COLQ123\_Affected\_CPN\_07272021.pdf GBNG-14COLQ123\_Affected\_CPN\_07272021.csv

# Notification Text:

**PCN Status:** Final notification

**PCN Type:** Manufacturing Change

#### **Microchip Parts Affected:** Please open one of the files found in the Affected CPNs section.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

### Description of Change:

Qualification of MMT as a new assembly site for selected Microsemi LX3301A device family available in 14L TSSOP (4.4mm)

package.

#### Pre and Post Change Summary:

	Pre Change	Post Change					
Assembly Site	UTAC Thai Limited (UTL-1) LTD. (NSEB)	Microchip Technology Thailand (Branch)					
		(MMT)					
Wire material	PdCu	Au					
Die attach material	8200T	2200D					
Molding compound material	G605L	G600V					
Lead frame material	C7025	C7025					
Lead frame DAP surface prep	Bare Copper Spot Ag	Bare Copper Selective Ag					
Lead frame design	Please see attached pre and post change comparison						

#### Impacts to Data Sheet:

None

### Change Impact:

None

#### Reason for Change:

To improve on-time delivery performance by qualifying MMT as a new assembly site.

### Change Implementation Status:

In Progress

### Estimated First Ship Date:

August 16, 2021 (date code: 2134)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

#### Time Table Summary:

	July 2021				August 2021					
Workweek	27	28	29	30	31	32	33	34	35	36
Qual Report Availability					Х					
Final PCN Issue Date					Х					
Estimated Implementation Date								Х		

### Method to Identify Change:

Traceability code

### **Qualification Report:** Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

#### **Revision History:** July 27, 2021: Issued final notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

## Attachments:

### PCN\_GBNG-14COLQ123\_Qual\_Report.pdf PCN\_GBNG-14COLQ123\_Pre and Post Change\_Summary.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

### Terms and Conditions:

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our PCN home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the PCN FAQ section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

GBNG-14COLQ123 - CCB 4485.001 Final Notice: Qualification of MMT as a new assembly site for selected Microsemi LX3301A device family available in 14L TSSOP (4.4mm) package.

Affected Catalog Part Numbers (CPN)

LX3301AQPW LX3301AQPW-TR